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CONFIRMATION NO. 3494

SERIAL NUMBER 10/802,563	FILING DATE 03/17/2004 RULE	CLASS 257	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. NUS03-001
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APPLICANTS

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** CONTINUING DATA ***** *NO*

** FOREIGN APPLICATIONS ***** *NO*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
 ** 06/01/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>[Signature]</i> Examiner's Signature Initials	STATE OR COUNTRY SINGAPORE	SHEETS DRAWING 4	TOTAL CLAIMS 34	INDEPENDENT CLAIMS 4
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TITLE
 Thermal robust semiconductor device using HfN as metal gate electrode and the manufacturing process thereof

FILING FEE RECEIVED 1308	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue)
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